

## 74F823 9-Bit D-Type Flip-Flop

### General Description

The 'F823 is a 9-bit buffered register. It features Clock Enable and Clear which are ideal for parity bus interfacing in high performance microprogramming systems.

The 'F823 is functionally and pin compatible with AMD's Am29823.

### Features

- 3-STATE outputs
- Clock Enable and Clear
- Direct replacement for AMD's Am29823

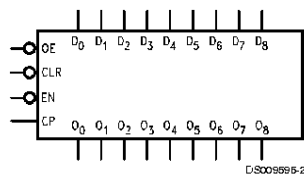
### Ordering Code:

Commercial	Military	Package Number	Package Description
74F823SPC		N24C	24-Lead (0.300" Wide) Molded Dual-In-Line
	54F823SDM (Note 2)	J24F	24-Lead (0.300" Wide) Ceramic Dual-In-Line
74F823SC (Note 1)		M24B	24-Lead (0.300" Wide) Molded Small Outline, JEDEC
	54F823FM (Note 2)	W24C	24-Lead Cerpack
	54F823LM (Note 2)	E28A	24-Lead Ceramic Chip Carrier, Type C

**Note 1:** Devices also available in 13" reel. Use suffix = SCX

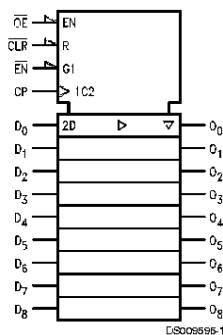
**Note 2:** Military grade device with environmental and burn-in processing. Use suffix = SDMQB, FMQB and LMQB

### Logic Symbol



DS009596-2

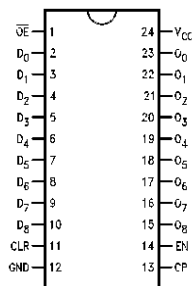
#### IEEE/IEC



DS009596-1

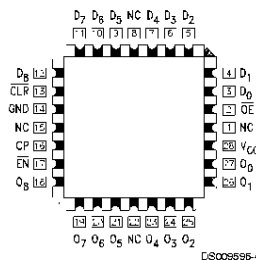
### Connection Diagrams

#### Pin Assignment for DIP, SOIC and Flatpak



DS009596-3

#### Pin Assignment for LCC



DS009596-4

## Connection Diagrams (Continued)

### Unit Loading/Fan Out

Pin Names	Description	54F/74F	
		U.L. HIGH/LOW	Input $I_{IH}/I_{IL}$ Output $I_{OH}/I_{OL}$
$D_0-D_8$	Data Inputs	1.0/1.0	20 $\mu$ A/-0.6 mA
$\overline{OE}$	Output Enable Input	1.0/1.0	20 $\mu$ A/-0.6 mA
$\overline{CLR}$	Clear	1.0/1.0	20 $\mu$ A/-0.6 mA
CP	Clock Input	1.0/2.0	20 $\mu$ A/-1.2 mA
$\overline{EN}$	Clock Enable	1.0/1.0	20 $\mu$ A/-0.6 mA
$O_0-O_8$	3-STATE Outputs	150/40 (33.3)	-3 mA/24 mA (20 mA)

### Functional Description

The 'F823 device consists of nine D-type edge-triggered flip-flops. It has 3-STATE true outputs and is organized in broadside pinning. The buffered Clock (CP) and buffered Output Enable ( $\overline{OE}$ ) are common to all flip-flops. The flip-flops will store the state of their individual D inputs that meet the setup and hold times requirements on the LOW-to-HIGH CP transition. With the  $\overline{OE}$  LOW the contents of the flip-flops are available at the outputs. When the  $\overline{OE}$  is HIGH, the outputs go to the high impedance state. Operation

of the  $\overline{OE}$  input does not affect the state of the flip-flops. In addition to the Clock and Output Enable pins, the 'F823 has Clear ( $\overline{CLR}$ ) and Clock Enable ( $\overline{EN}$ ) pins.

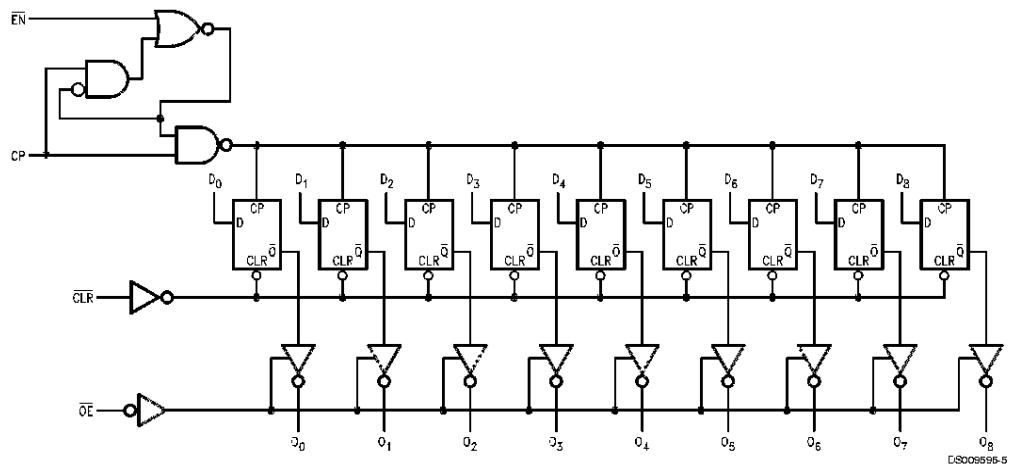
When the  $\overline{CLR}$  is LOW and the  $\overline{OE}$  is LOW, the outputs are LOW. When  $\overline{CLR}$  is HIGH, data can be entered into the flip-flops. When  $\overline{EN}$  is LOW, data on the inputs is transferred to the outputs on the LOW to HIGH clock transition. When the  $\overline{EN}$  is HIGH, the outputs do not change state regardless of the data or clock inputs transitions. This device is ideal for parity bus interfacing in high performance systems.

### Function Table

Inputs					Internal	Output	Function
$\overline{OE}$	$\overline{CLR}$	$\overline{EN}$	CP	D	$\overline{Q}$	O	
H	H	L	H	X	NC	Z	Hold
H	H	L	L	X	NC	Z	Hold
H	H	H	X	X	NC	Z	Hold
L	H	H	X	X	NC	NC	Hold
H	L	X	X	X	H	Z	Clear
L	L	X	X	X	H	L	Clear
H	H	L	$\nearrow$	H	H	Z	Load
H	H	L	$\nearrow$	H	L	Z	Load
L	H	L	$\nearrow$	L	H	L	Data Available
L	H	L	$\nearrow$	H	L	H	Data Available
L	H	L	H	X	NC	NC	No Change in Data
L	H	L	L	X	NC	NC	No Change in Data

L = LOW Voltage Level  
H = HIGH Voltage Level  
X = Immaterial  
Z = High Impedance  
 $\nearrow$  = LOW-to-HIGH Transition  
NC = No Change

## Logic Diagram



### Absolute Maximum Ratings (Note 3)

Storage Temperature	-65°C to +150°C
Ambient Temperature under Bias	-55°C to +125°C
Junction Temperature under Bias	-55°C to +175°C
Plastic	-55°C to +150°C
V <sub>CC</sub> Pin Potential to Ground Pin	-0.5V to +7.0V
Input Voltage (Note 4)	-0.5V to +7.0V
Input Current (Note 4)	-30 mA to +5.0 mA
Voltage Applied to Output in HIGH State (with V <sub>CC</sub> = 0V)	
Standard Output	-0.5V to V <sub>CC</sub>
3-STATE Output	-0.5V to +5.5V
Current Applied to Output	

in LOW State (Max)

twice the rated I<sub>OL</sub> (mA)

### Recommended Operating Conditions

Free Air Ambient Temperature	
Military	-55°C to +125°C
Commercial	0°C to +70°C
Supply Voltage	
Military	+4.5V to +5.5V
Commercial	+4.5V to +5.5V

**Note 3:** Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

**Note 4:** Either voltage limit or current limit is sufficient to protect inputs.

### DC Electrical Characteristics

Symbol	Parameter	54F/74F			Units	V <sub>CC</sub>	Conditions
		Min	Typ	Max			
V <sub>IH</sub>	Input HIGH Voltage	2.0			V		Recognized as a HIGH Signal
V <sub>IL</sub>	Input LOW Voltage				V		Recognized as a LOW Signal
V <sub>CD</sub>	Input Clamp Diode Voltage				V	Min	I <sub>IN</sub> = -18 mA
V <sub>OH</sub>	Output HIGH Voltage	54F 10% V <sub>CC</sub>	2.5		V	Min	I <sub>OH</sub> = -1 mA
		54F 10% V <sub>CC</sub>	2.4				I <sub>OH</sub> = -3 mA
		74F 10% V <sub>CC</sub>	2.5				I <sub>OH</sub> = -1 mA
		74F 10% V <sub>CC</sub>	2.4				I <sub>OH</sub> = -3 mA
		74F 5% V <sub>CC</sub>	2.7				I <sub>OH</sub> = -1 mA
		74F 5% V <sub>CC</sub>	2.7				I <sub>OH</sub> = -3 mA
V <sub>OL</sub>	Output LOW Voltage	54F 10% V <sub>CC</sub>			V	Min	I <sub>OL</sub> = 20 mA
		74F 10% V <sub>CC</sub>					I <sub>OL</sub> = 24 mA
I <sub>IH</sub>	Input HIGH Current	54F			μA	Max	V <sub>IN</sub> = 2.7V
		74F					
I <sub>BVI</sub>	Input HIGH Current Breakdown Test	54F			μA	Max	V <sub>IN</sub> = 7.0V
		74F					
I <sub>CEX</sub>	Output HIGH Leakage Current	54F			μA	Max	V <sub>OUT</sub> = V <sub>CC</sub>
		74F					
V <sub>ID</sub>	Input Leakage Test	74F	4.75		V	0.0	I <sub>ID</sub> = 1.9 μA All Other Pins Grounded
I <sub>OD</sub>	Output Leakage Circuit Current	74F			μA	0.0	V <sub>IOD</sub> = 150 mV All Other Pins Grounded
I <sub>IL</sub>	Input LOW Current			-0.6	mA	Max	V <sub>IN</sub> = 0.5V (OE, CLR, EN)
				-1.2	mA	Max	V <sub>IN</sub> = 0.5V (CP)
I <sub>OZH</sub>	Output Leakage Current			50	μA	Max	V <sub>OUT</sub> = 2.7V
I <sub>OZL</sub>	Output Leakage Current			-50	μA	Max	V <sub>OUT</sub> = 0.5V
I <sub>OS</sub>	Output Short-Circuit Current	-60	-150		mA	Max	V <sub>OUT</sub> = 0V
I <sub>ZZ</sub>	Buss Drainage Test			500	μA	0.0V	V <sub>OUT</sub> = 5.25V
I <sub>CCZ</sub>	Power Supply Current	75	100		mA	Max	V <sub>O</sub> = HIGH Z

## AC Electrical Characteristics

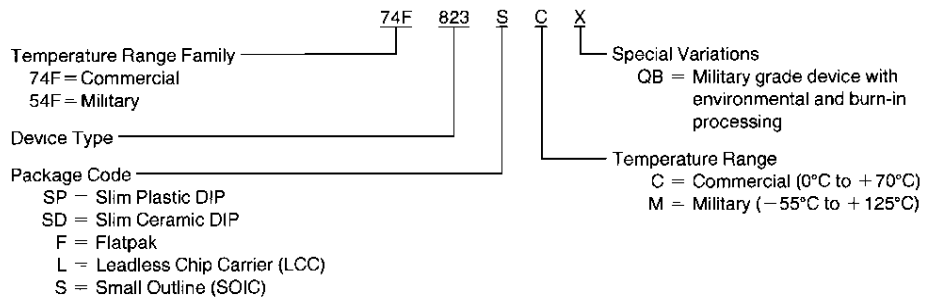
Symbol	Parameter	74F			54F		74F		Units
		$T_A = +25^\circ\text{C}$ $V_{CC} = +5.0\text{V}$ $C_L = 50\text{ pF}$			$T_A, V_{CC} = \text{Mil}$ $C_L = 50\text{ pF}$		$T_A, V_{CC} = \text{Com}$ $C_L = 50\text{ pF}$		
		Min	Typ	Max	Min	Max	Min	Max	
$f_{\text{max}}$	Maximum Clock Frequency	100	160		60		70		MHz
$t_{\text{PLH}}$	Propagation Delay	2.0	5.6	9.5	2.0	10.5	2.0	10.5	ns
$t_{\text{PHL}}$	CP to $O_n$	2.0	5.2	9.5	2.0	10.5	2.0	10.5	
$t_{\text{PHL}}$	Propagation Delay CLR to $O_n$	4.0	7.1	12.0	4.0	13.0	4.0	13.0	ns
$t_{\text{PZH}}$	Output Enable Time	2.0	5.8	10.5	2.0	13.0	2.0	11.5	ns
$t_{\text{PZL}}$	$\overline{\text{OE}}$ to $O_n$	2.0	5.5	10.5	2.0	13.0	2.0	11.5	
$t_{\text{PHZ}}$	Output Disable Time	1.5	2.9	7.0	1.0	7.5	1.5	7.5	
$t_{\text{PLZ}}$	$\overline{\text{OE}}$ to $O_n$	1.5	2.7	7.0	1.0	7.5	1.5	7.5	

## AC Operating Requirements

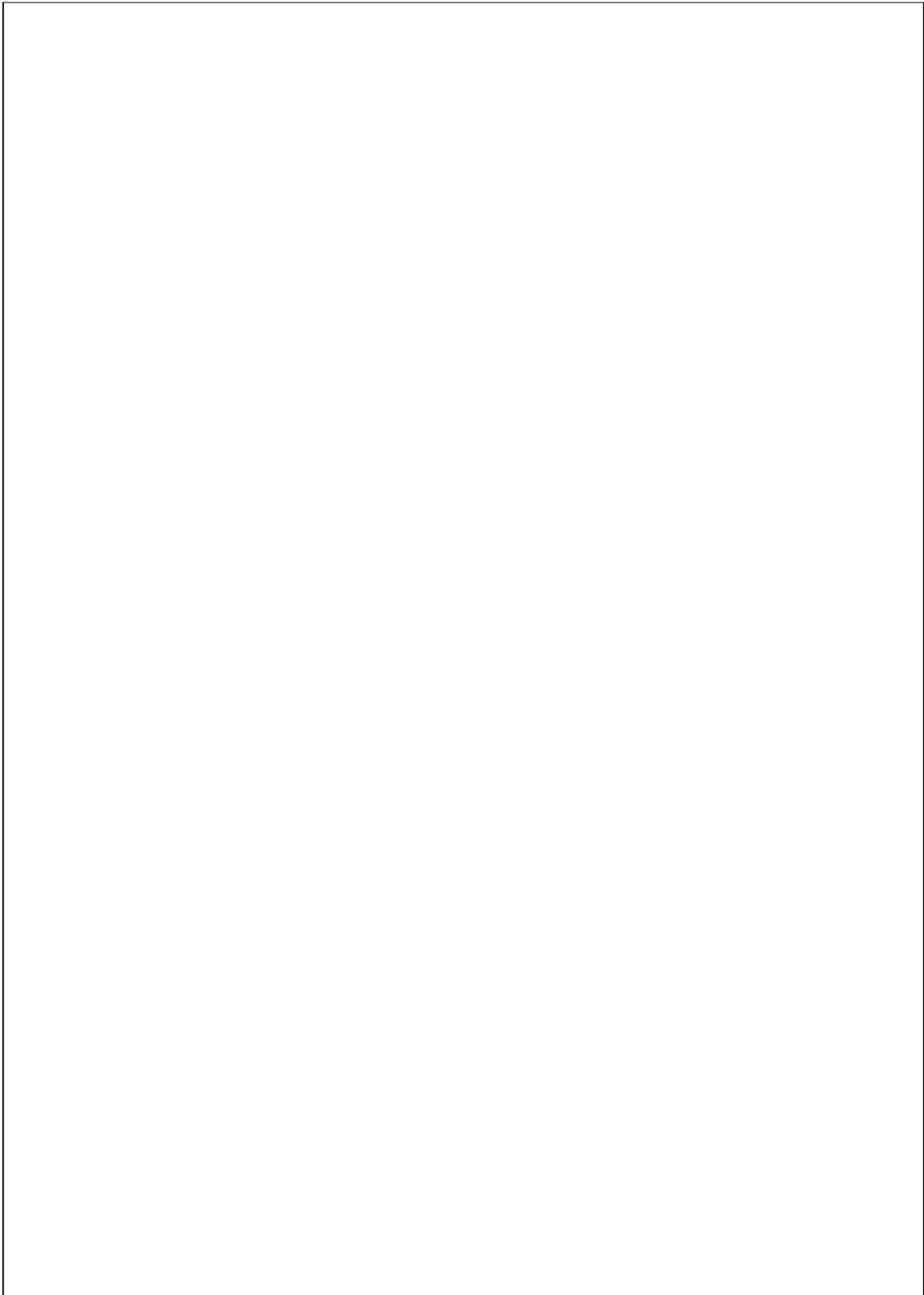
Symbol	Parameter	74F		54F		74F		Units
		$T_A = +25^\circ\text{C}$ $V_{CC} = +5.0\text{V}$		$T_A, V_{CC} = \text{Mil}$		$T_A, V_{CC} = \text{Com}$		
		Min	Max	Min	Max	Min	Max	
$t_s(\text{H})$	Setup Time, HIGH or LOW	2.5		4.0		3.0		ns
$t_s(\text{L})$	$D_n$ to CP	2.5		4.0		3.0		
$t_h(\text{H})$	Hold Time, HIGH or LOW	2.5		2.5		2.5		ns
$t_h(\text{L})$	$D_n$ to CP	2.5		2.5		2.5		
$t_s(\text{H})$	Setup Time, HIGH or LOW	4.5		5.0		5.0		ns
$t_s(\text{L})$	$\overline{\text{EN}}$ to CP	2.5		3.0		3.0		
$t_h(\text{H})$	Hold Time, HIGH or LOW	2.0		3.0		2.0		
$t_h(\text{L})$	$\overline{\text{EN}}$ to CP	0		1.0		0		
$t_w(\text{H})$	CP Pulse Width	5.0		6.0		6.0		ns
$t_w(\text{L})$	HIGH or LOW	5.0		6.0		6.0		
$t_w(\text{L})$	CLR Pulse Width, LOW	5.0		5.0		5.0		ns
$t_{\text{rec}}$	$\overline{\text{CLR}}$ Recovery Time	5.0		5.0		5.0		ns

## Ordering Information

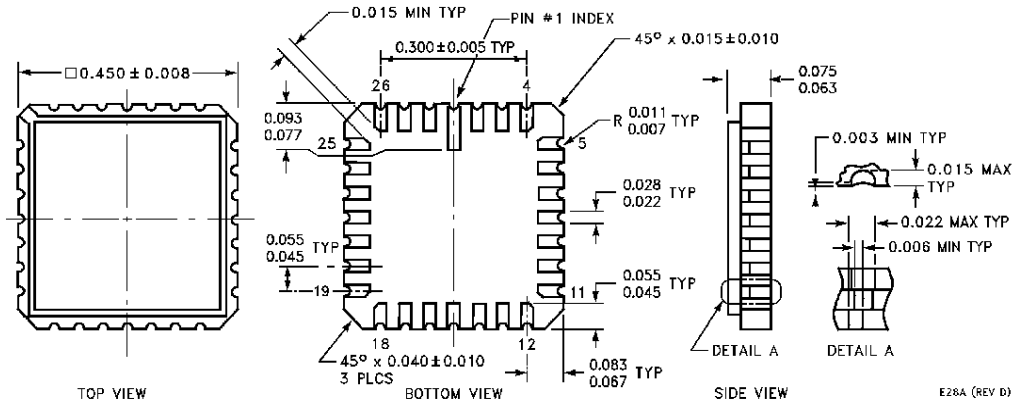
The device number is used to form part of a simplified purchasing code where the package type and temperature range are defined as follows:



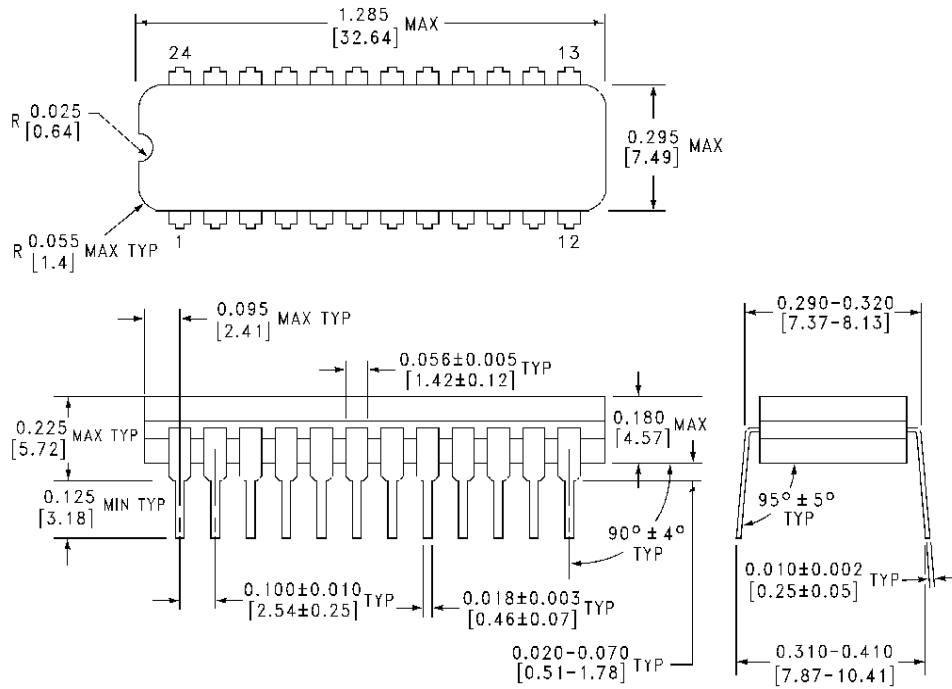
D800999-5



**Physical Dimensions** inches (millimeters) unless otherwise noted



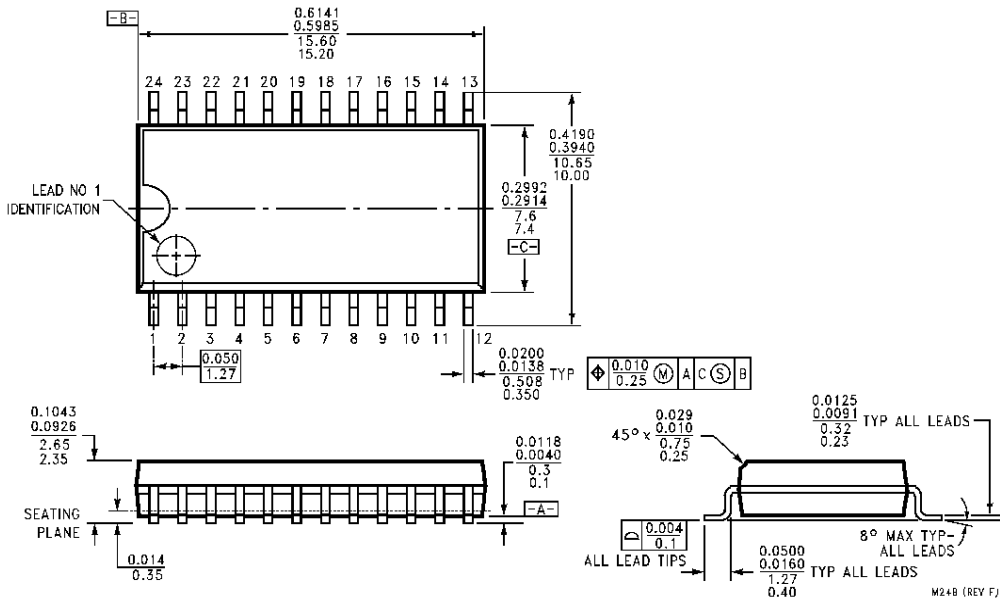
**28-Lead Ceramic Leadless Chip Carrier, Type C (L)**  
**Package Number E28A**



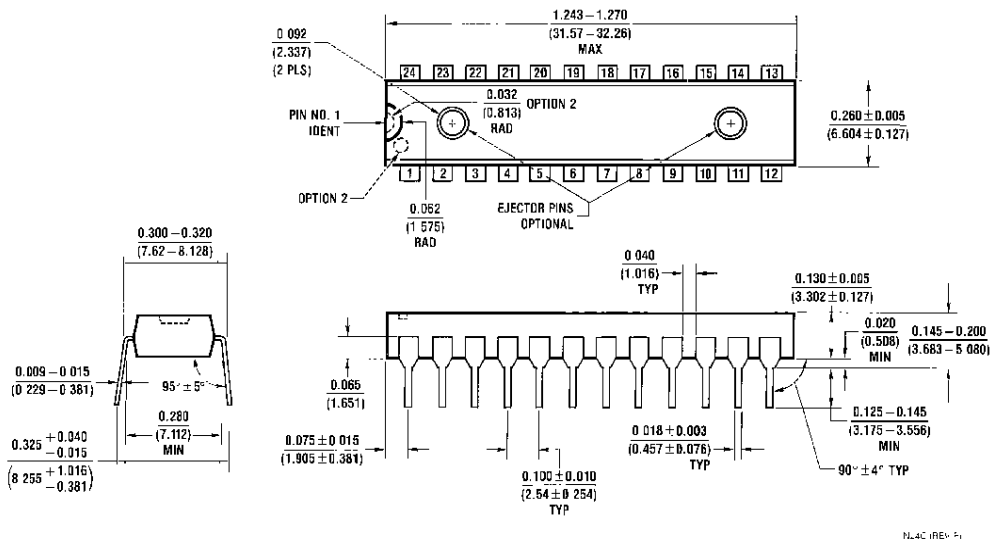
**24-Lead (0.300" Wide) Ceramic Dual-In-Line Package (SD)**  
**Package Number J24F**



**Physical Dimensions** inches (millimeters) unless otherwise noted (Continued)

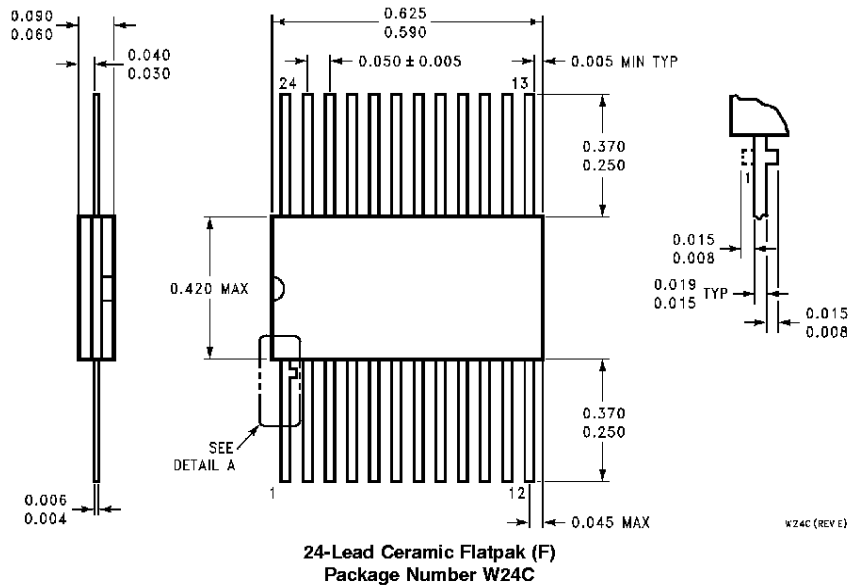


**24-Lead (0.300" Wide) Molded Small Outline Package, JEDEC (S)  
Package Number M24B**



**24-Lead (0.300" Wide) Molded Dual-In-Line Package (SP)  
Package Number N24C**

**Physical Dimensions** inches (millimeters) unless otherwise noted (Continued)



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